



Design of Functionally Graded Piezocomposite Materials Using Topology Optimization with Polygonal Mesh

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Acknowledgements:



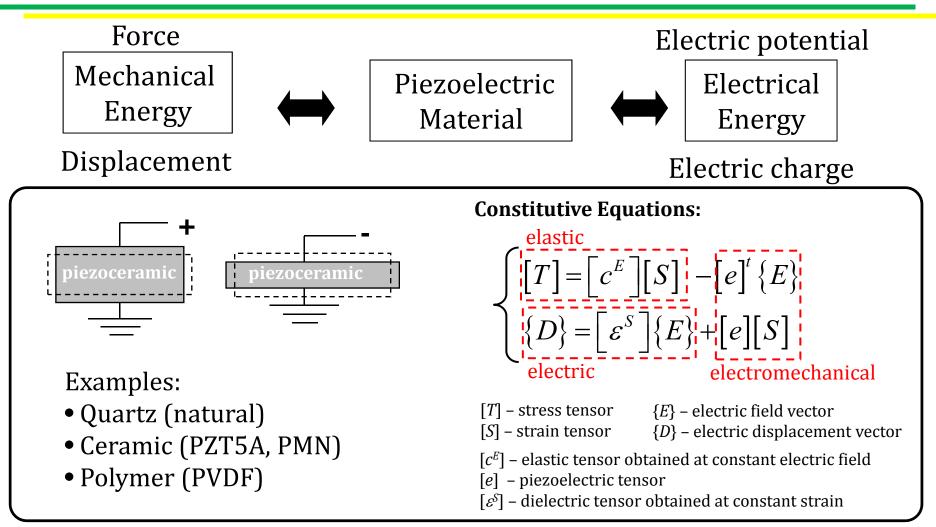


Outline

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- Introduction and Motivation
- > Objective
- > Theoretical Topics
 - Polygonal Mesh
 - Topology Optimization
- > Numerical Results
- > Conclusions and Future Works

Piezoelectric Materials



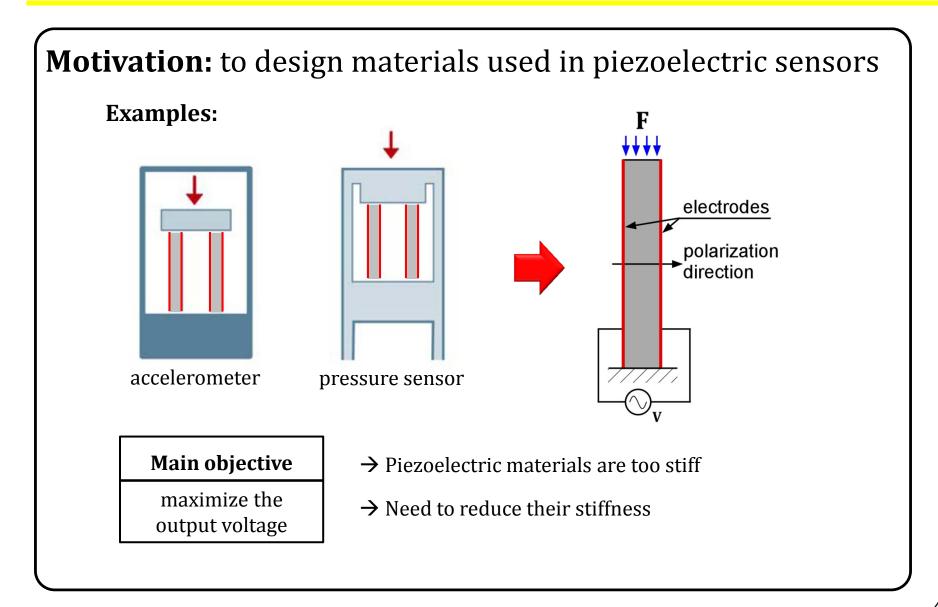
Applications: ultrasonic transducers, actuators, pressure sensors, accelerometers, sonar, hydrophones, MEMS, etc...

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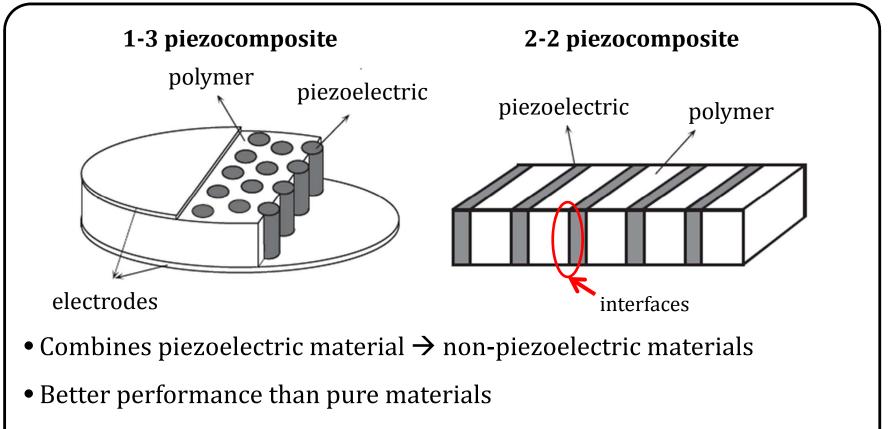
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Motivation

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Piezocomposite Materials



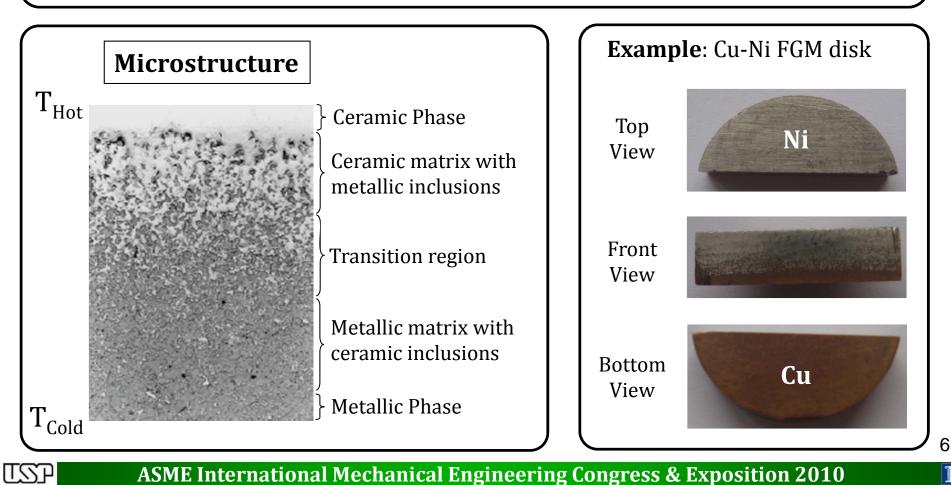
- Depends on: volume fractions, material properties, shape of inclusions
- Interfaces: might present stress concentrations, which may cause material fracture and fatigue.

Newnham RE, Skinner DP, Cross LE, "Connectivity And Piezoelectric-Pyroelectric Composites", Materials Research Bulletin, Pergamon-Elsevier Science Ltd, 1978, 13, 525-536.

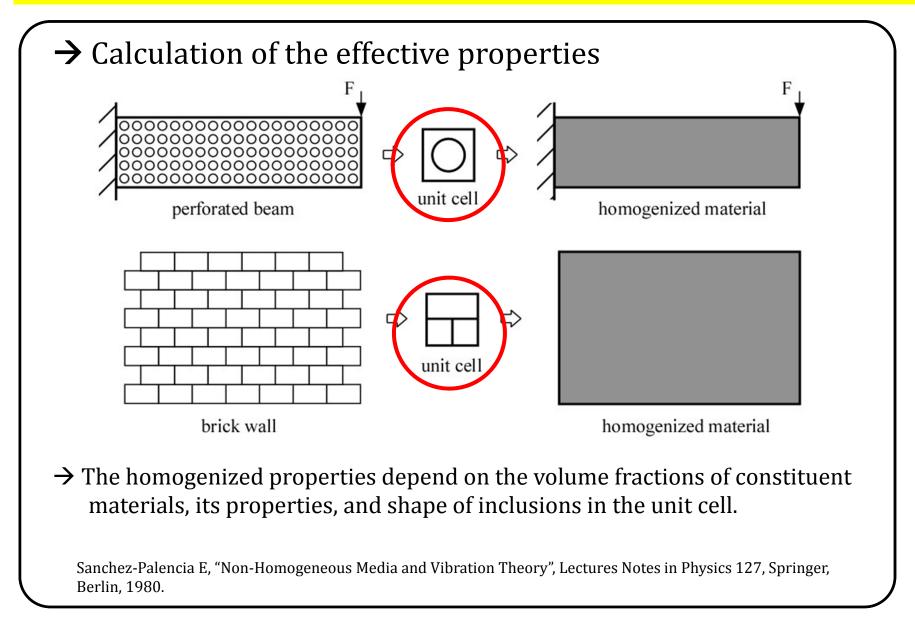
Functionally Graded Materials (FGM)

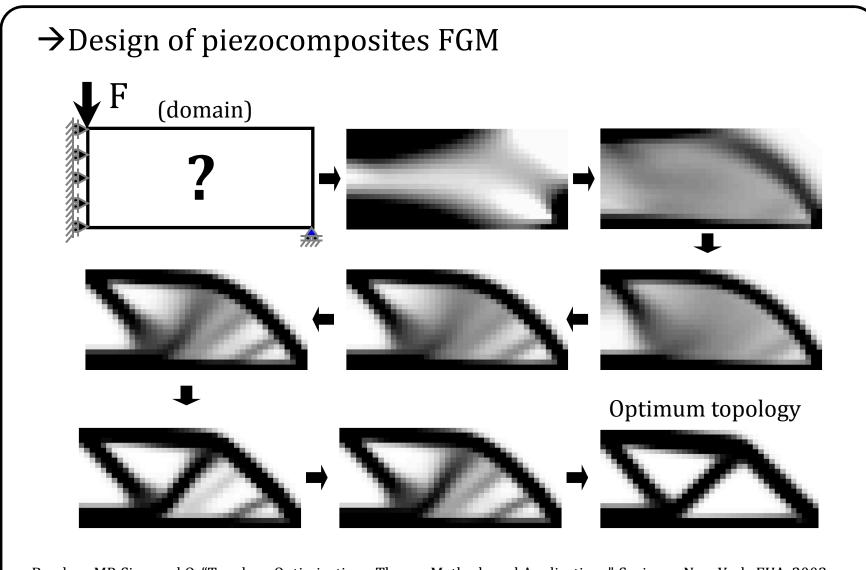
FGMs possess continuously graded properties with gradual change in microstructure which avoids interface problems, such as, stress concentrations.

Miyamoto, Y., Kaysser, W. A., Rabin, B. H., and and R. G. Ford, A. K., "Functionally Graded Materials: Design, Processing and Applications", Kluwer Academic Publishers, Dordrecht, 1999.



Homogenization Method





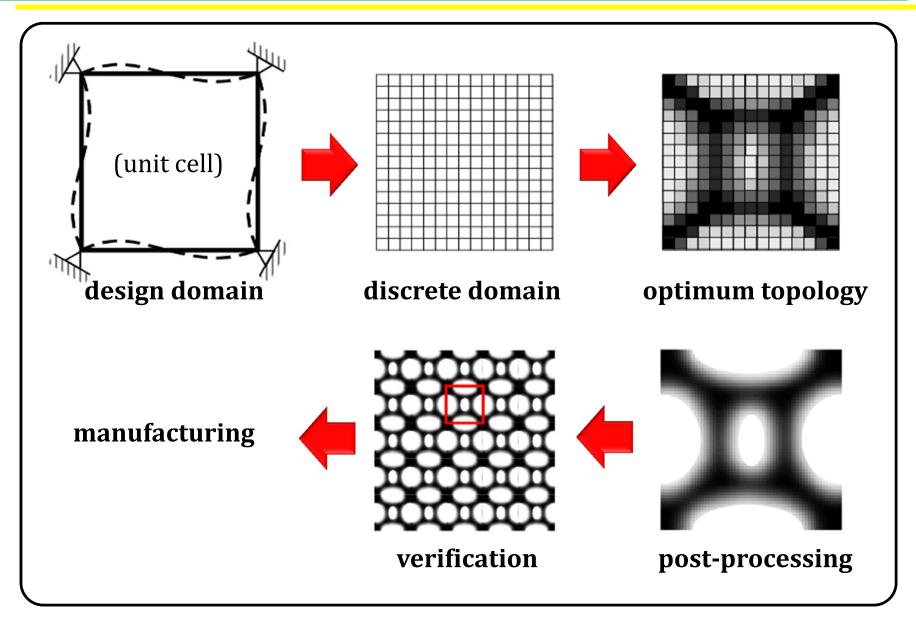
Bendsoe MP, Sigmund O, "Topology Optimization - Theory, Methods and Applications". Springer, New York, EUA, 2003.



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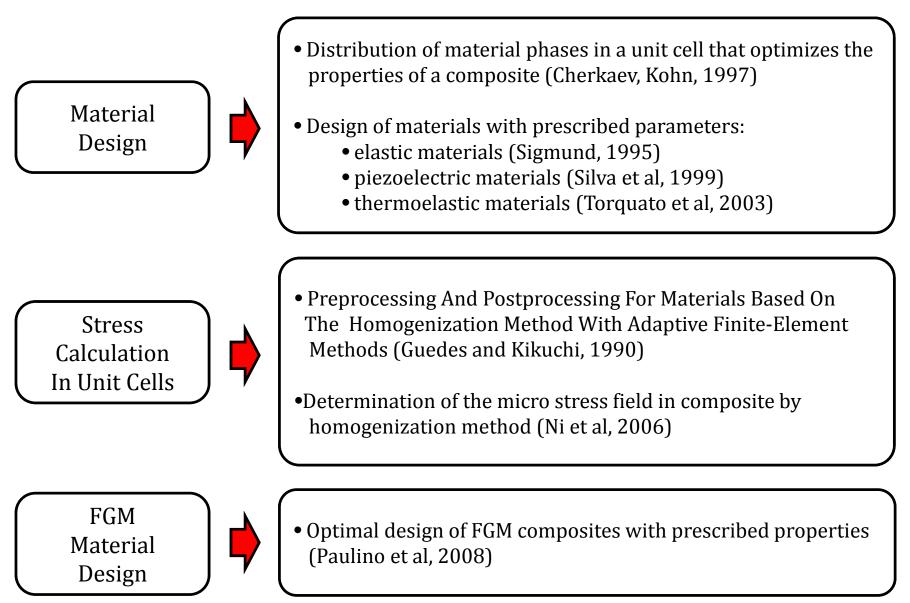
Piezocomposite Design Using TOM

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Previous works

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To design <u>piezocomposite materials</u> based on <u>FGM concept</u> using <u>topology optimization</u> and <u>homogenization methods</u>, in order to <u>maximize the output voltage</u> of piezoelectric sensors.

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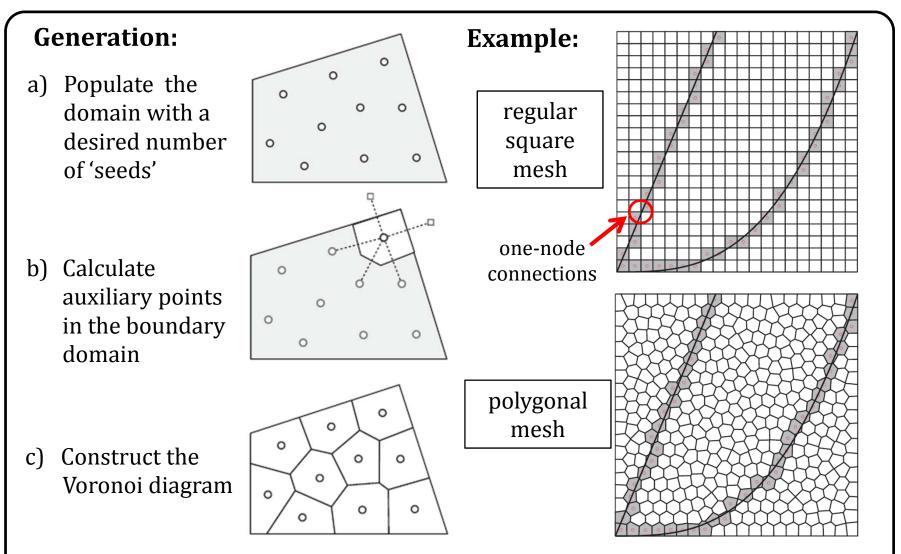
> Objective

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Polygonal Mesh

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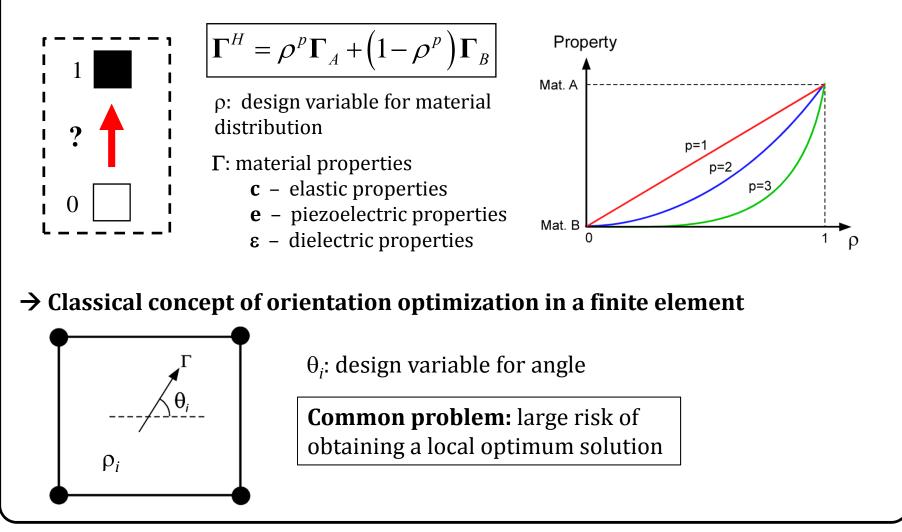
Talischi C, Paulino GH, Pereira A, Menezes, IFM, "Polygonal finite elements for topology optimization: A unifying paradigm", International Journal for Numerical Methods in Engineering, 2009, 28

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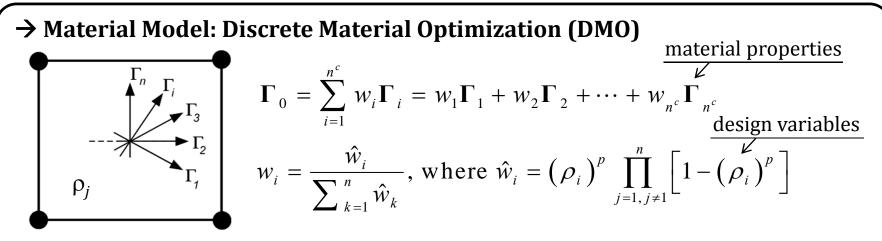
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\rightarrow How to change the material from zero to one?

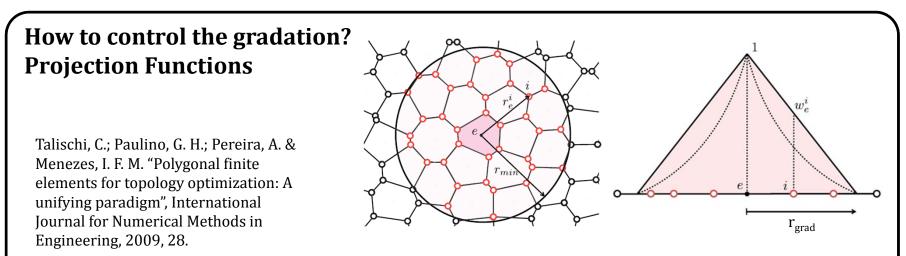
Bendsoe MP, Sigmund O, "Topology Optimization - Theory, Methods and Applications". Springer, New York, EUA, 2003.



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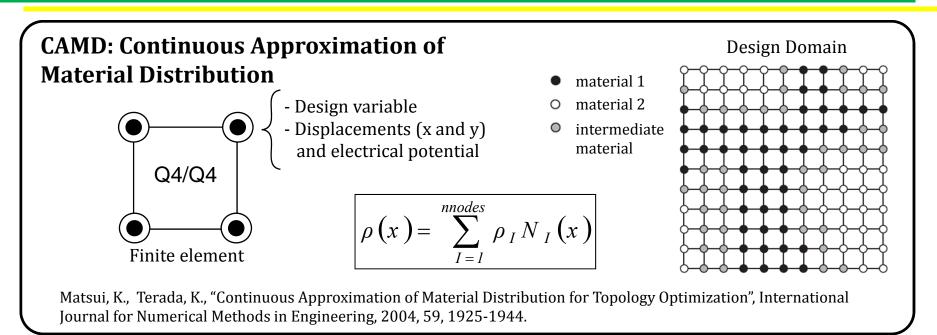


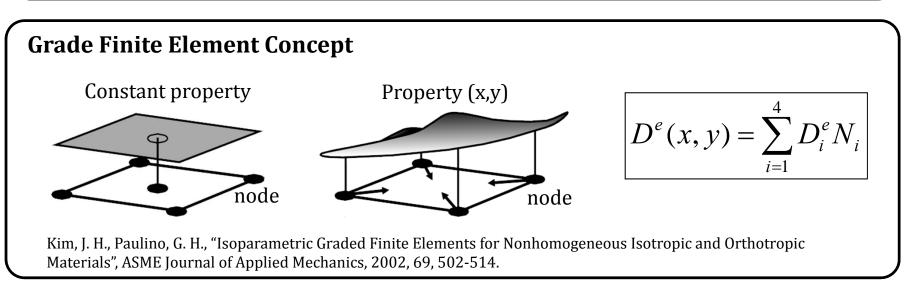
Stegmann J, Lund E, "Discrete material optimization of general composite shell structures", International Journal for Numerical Methods in Engineering, 2005; 62, p. 2009–2027



Guest, J. K.; Prévost, J. H. & Belytschko, T., "Achieving minimum length scale in topology optimization using nodal design variables and projection functions", International Journal for Numerical Methods in Engineering, 2004, 61, 238-254.

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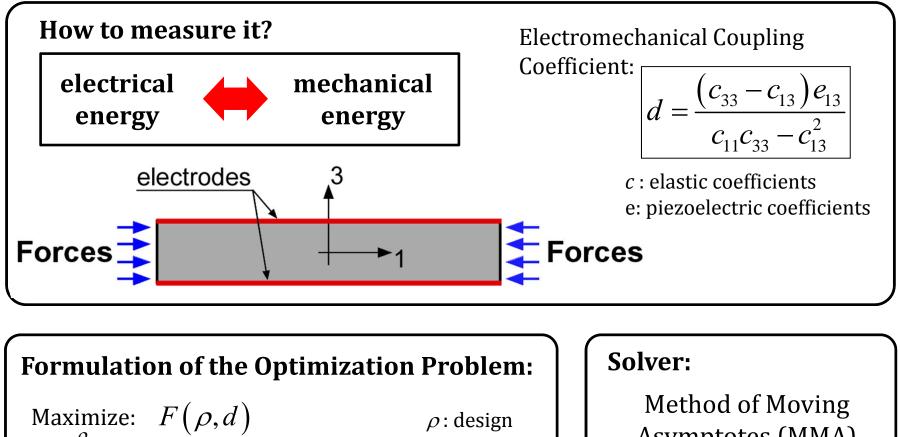
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subject to: $0 \le \rho \le 1$

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symmetry conditions

gradation control



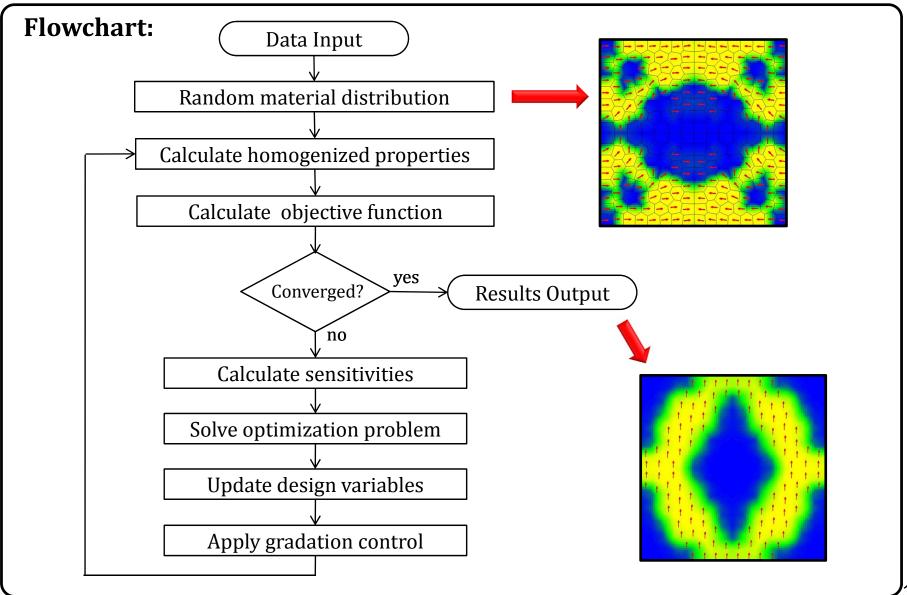
Method of Moving Asymptotes (MMA)

Svanberg, K., "The method of moving asymptotes - A new method for structural optimization," International Journal for Numerical Methods in Engineering, Vol. 24, 1987, pp. 359-373.

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 ρ : design

variables

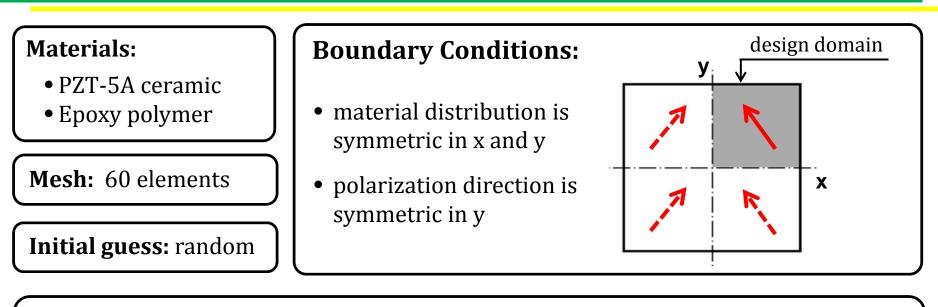


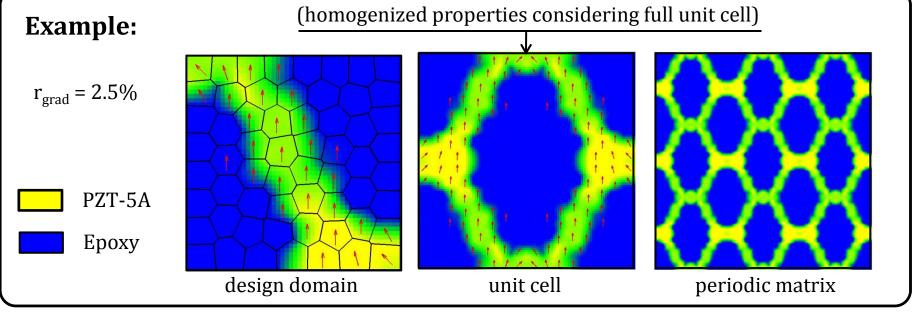
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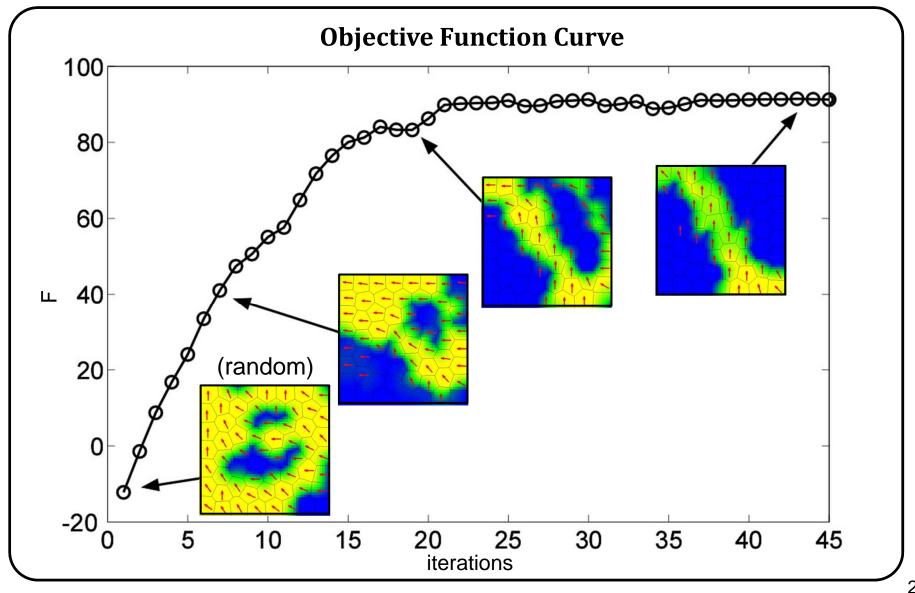
Numerical Results: Parameters

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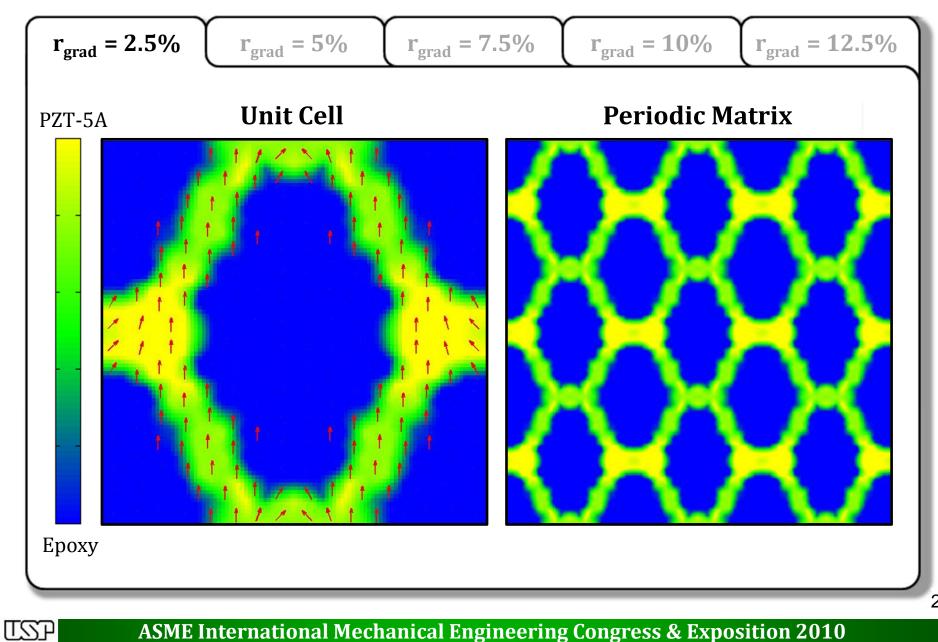
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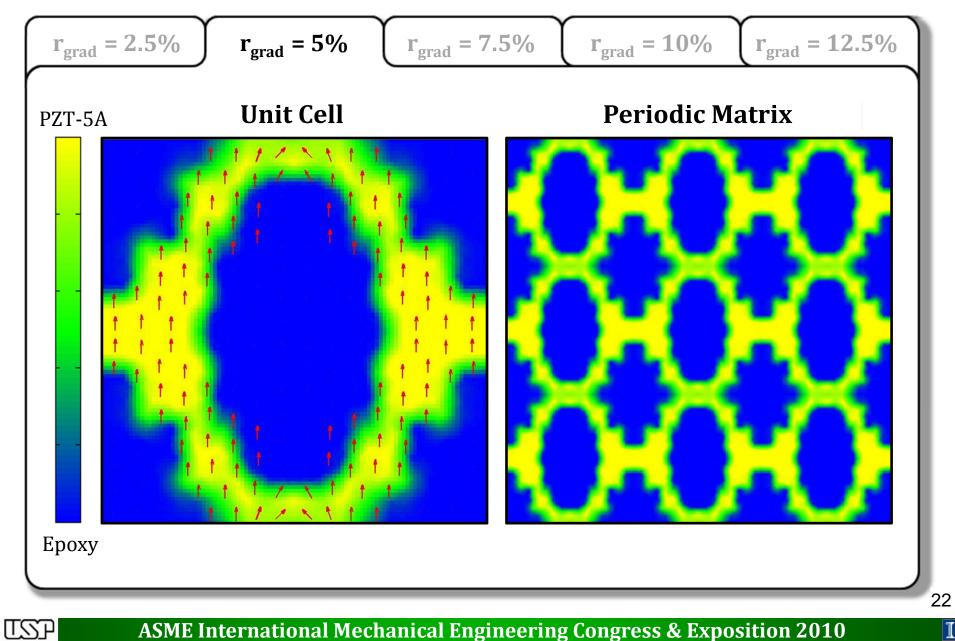
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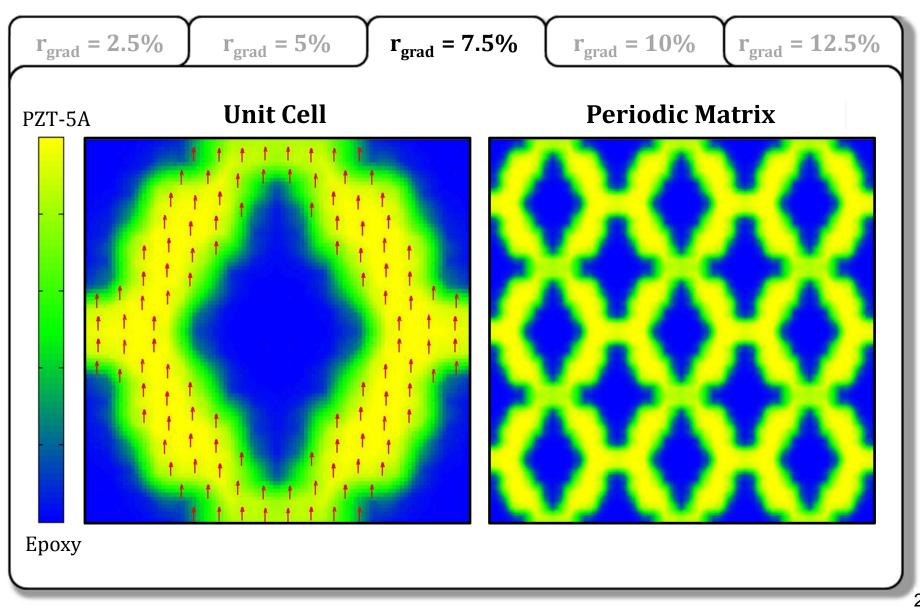
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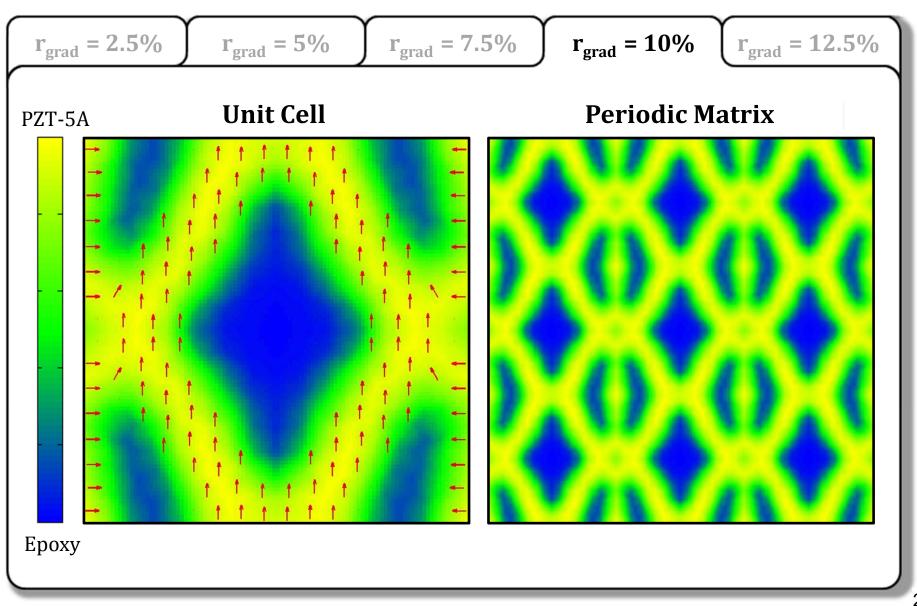
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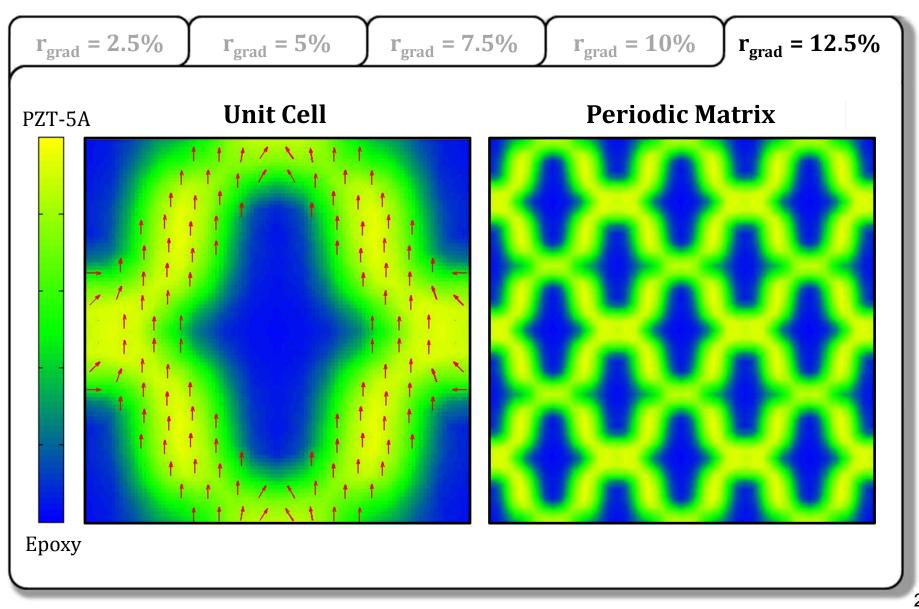
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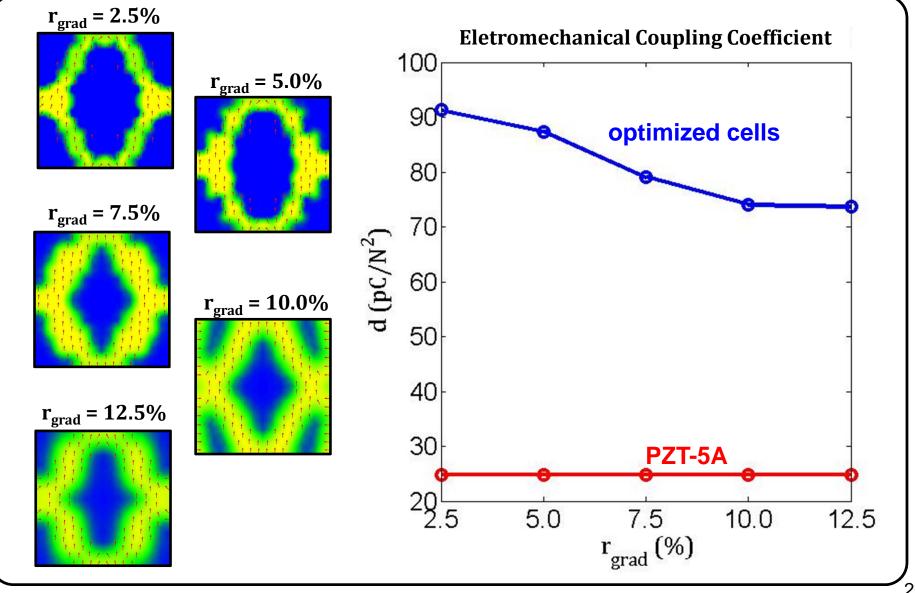
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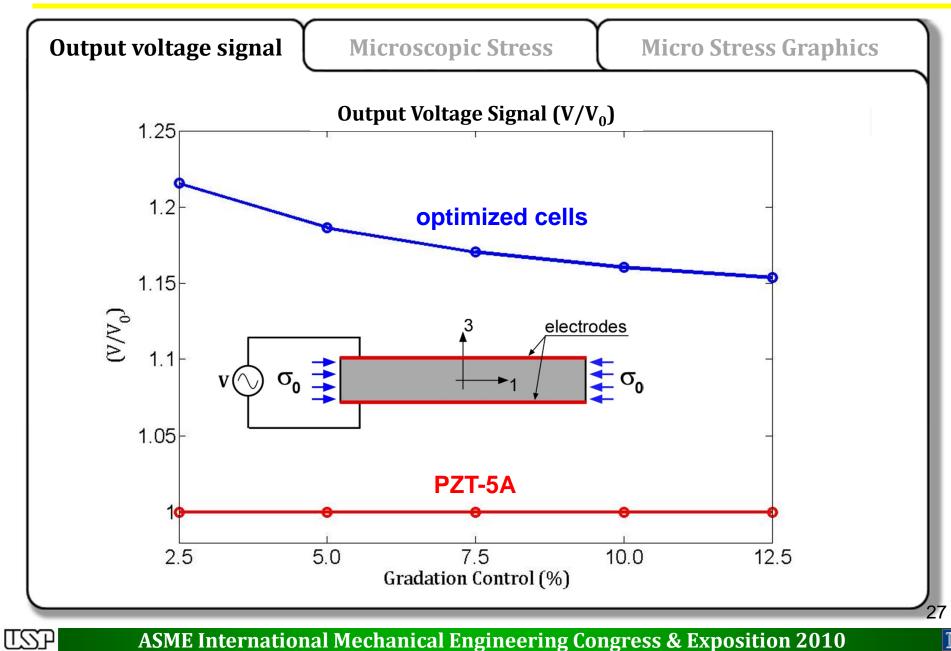


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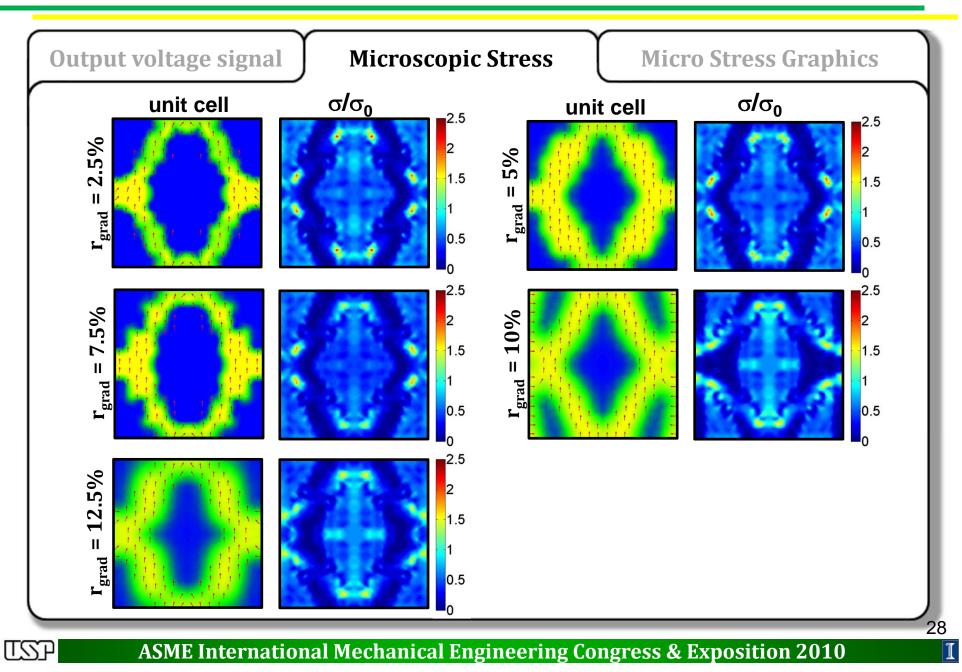
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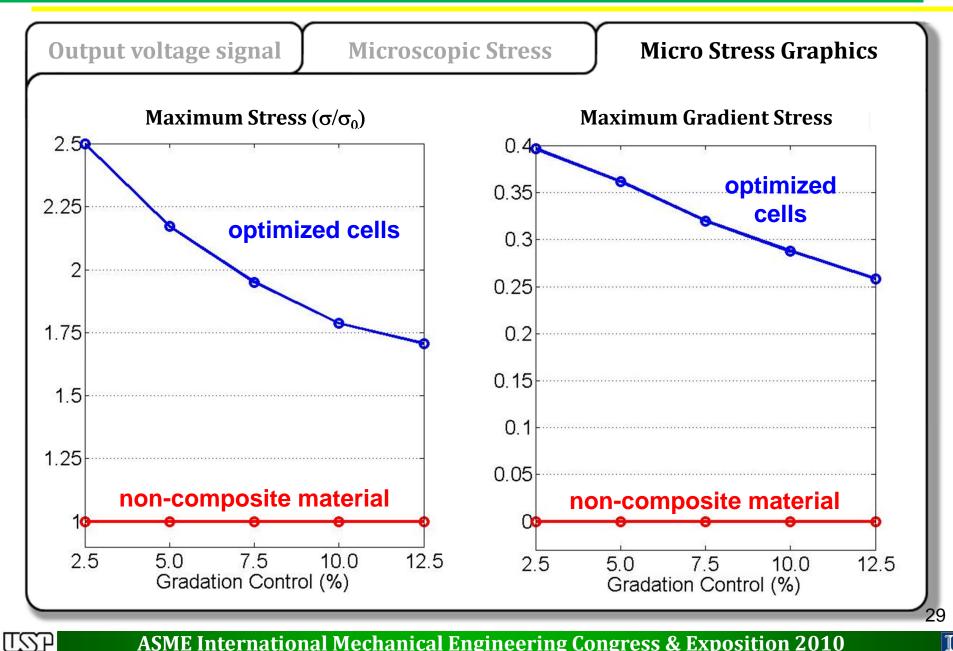
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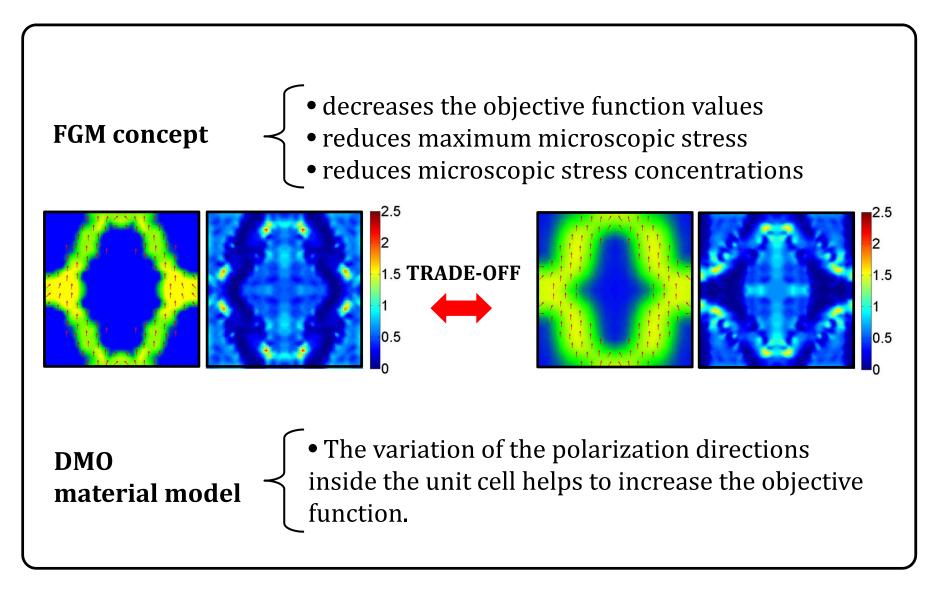




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Conclusions

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Thank you!

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